

UNISONIC TECHNOLOGIES CO., LTD

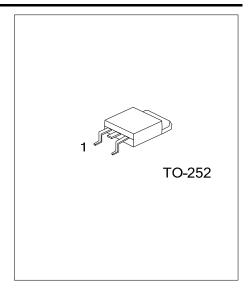
UTT50N05 Preliminary Power MOSFET

50A, 50V N-CHANNEL ENHANCEMENT MODE POWER MOSFET TRANSISTOR

■ DESCRIPTION

The UTC **UTT50N05** is an N-channel enhancement power MOSFET using UTC's advanced technology to provide the customers with perfect $R_{DS(ON)}$, high switching speed, high current capacity and low gate charge.

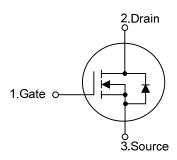
The UTC **UTT50N05** is suitable for motor control, AC-DC or DC-DC converters and audio amplifiers, etc.



■ FEATURES

- * $R_{DS(ON)}$ =18m Ω @ V_{GS} =10V, I_D =20A
- * High Switching Speed
- * High Current Capacity
- * Low Gate Charge(typical 30nC)

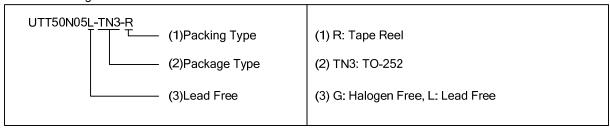
■ SYMBOL



ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking
Lead Free	Halogen Free	Package	1	2	3	Packing
UTT50N05L-TN3-R	UTT50N05G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



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■ ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	50	V
Gate-Source Voltage		V_{GSS}	±20	V
Drain Current	Continuous	I _D	50	Α
Dialii Cuirelli	Pulsed	I _{DM}	200	Α
Avalancha Energy	Single Pulsed	E _{AS}	400	mJ
Avalanche Energy	Repetitive	E _{AR}	100	mJ
Power Dissipation		P_{D}	113	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T _{STG}	-55 ~ + 150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	100	°C/W	
Junction to Case	θ_{JC}	1.1	°C/W	

■ ELECTRICAL CHARACTERISTICS

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV_{DSS}	I _D =250μA, V _{GS} =0V	50			V	
Drain-Source Leakage Current		I_{DSS}	V _{DS} =100V, V _{GS} =0V			10	μΑ	
Gate- Source Leakage Current	Forward	- I _{GSS}	V_{GS} =+20V, V_{DS} =0V			+100	nA	
Gate- Source Leakage Current	Reverse		V _{GS} =-20V, V _{DS} =0V			-100	nA	
ON CHARACTERISTICS	ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2		4	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =20A		18	23	mΩ	
DYNAMIC PARAMETERS								
Input Capacitance		C _{ISS}			900	1220	pF	
Output Capacitance		Coss	V_{GS} =0V, V_{DS} =25V, f=1.0MHz		430	550	pF	
Reverse Transfer Capacitance		C_{RSS}			80	100	pF	
SWITCHING PARAMETERS								
Total Gate Charge		Q_G	V _{GS} =10V, V _{DS} =30V, I _D =50A,		30	40	nC	
Gate to Source Charge		Q_GS	$I_{G}=3.33$ mA		9.6		nC	
Gate to Drain Charge		Q_{GD}	IG-0.00IIIA		10		nC	
Turn-ON Delay Time		$t_{D(ON)}$			40	60	ns	
Rise Time		t_R	V_{DD} =30V, I_{D} =15A, R_{G} =2.5 Ω ,		100	200	ns	
Turn-OFF Delay Time		t _{D(OFF)}	V _{GS} =10V		90	180	ns	
Fall-Time		t _F			80	160	ns	
SOURCE- DRAIN DIODE RATIN	NGS AND C	CHARACTERI	STICS					
Maximum Body-Diode Continuou	us Current	Is		50			Α	
Maximum Body-Diode Pulsed Current		I _{SM}		200			Α	
Drain-Source Diode Forward Voltage		V _{SD}	I _S =50A, V _{GS} =0V			1.5	V	

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